

Digital Power Monitor with Clear Pin and ALERT Output

Data Sheet

FEATURES

Powered from 3.15 V to 26 V **Precision current sense amplifier Precision voltage input** 12-bit ADC for current and voltage readback ALERT output allows basic P-channel FET hot swap up to 26 V SETV input for setting overcurrent alert threshold Programmable overcurrent filtering via TIMER pin **CLRB** input pin I²C fast mode-compliant interface (400 kHz maximum) 10-lead MSOP

APPLICATIONS

Rev. D

Power monitoring/power budgeting **Central office equipment** Telecommunications and data communications equipment PCs/servers

GENERAL DESCRIPTION

The ADM1192 is an integrated current sense amplifier that offers digital current and voltage monitoring via an on-chip 12-bit analog-to-digital converter (ADC), communicated through an I²C[®] interface.

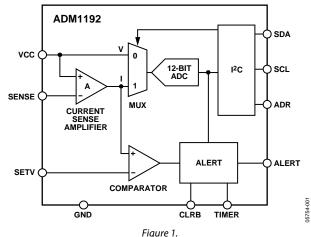
An internal current sense amplifier measures voltage across the sense resistor in the power path via the VCC pin and the SENSE pin.

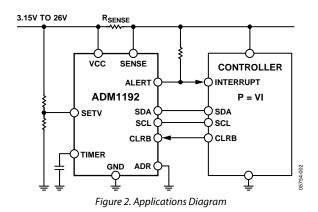
A 12-bit ADC can measure the current seen in the sense resistor and in the supply voltage on the VCC pin. An industry-standard I²C interface allows a controller to read current and voltage data from the ADC. Measurements can be initiated by an I²C command. Alternatively, the ADC can run continuously, and the user can read the latest conversion data whenever it is required. Up to four unique I²C addresses can be created, depending on the way the ADR pin is connected.

A SETV pin is also included. A voltage applied to this pin is internally compared with the output voltage on the current sense amplifier. The output of the SETV comparator asserts when the current sense amplifier output exceeds the SETV voltage. This event is detected at the ALERT block. The ALERT block then charges up the external TIMER capacitor with a fixed current. When this timing cycle is complete, the ALERT output asserts.

ADM1192

FUNCTIONAL BLOCK DIAGRAM





The ALERT output can be used as a flag to warn a microcontroller or field programmable gate array (FPGA) of an overcurrent condition. ALERT outputs of multiple ADM1192 devices can be tied together and used as a combined alert.

A basic P-channel FET hot swap circuit can be implemented with the ALERT output. The value of the TIMER capacitor should be set so that the charging time of this capacitor is much longer than the period during which a higher than nominal inrush current may be flowing.

The ADM1192 is packaged in a 10-lead MSOP.

Document Feedback

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

TABLE OF CONTENTS

Features
Applications1
General Description
Functional Block Diagram1
Revision History
Specifications
Absolute Maximum Ratings
Thermal Characteristics
ESD Caution
Pin Configuration and Function Descriptions
Typical Performance Characteristics
Voltage and Current Readback10
Serial Bus Interface10

REVISION HISTORY

7/13—Rev. C to Rev. D

Changed SETV Pin Rating, Table 2	5
Changes to CLRB Pin and ALERT Pin Descriptions, Table 4	
Changes to Table 15	15
Changes to the Implementing a Basic Hot Swap Circuit and th	ıe
SETV Pin Sections	16
Changes to Figure 28	16
Moved the Kelvin Sense Resistor Connection Section	16

6/12-Rev. B to Rev. C

Changes to Low Level Input Voltage, VIL Parameter, Test	
Conditions/Comments Column, Table 1 and High Level Input	ıt
Voltage, VIH Parameter, Test Conditions/Comments Column,	
Table 1	3
Changes to SETV Pin Parameter, Rating Column, Table 2	5
Changes to Pin 3, Description Column, Table 4 and Pin 10	
Description Column, Table 4	6
Changes to Bit 2, Function Column, Table 9	13
Changes to Overcurrent Flag Section	16
Changes to Kelvin Sense Resistor Connection Section	17
Deleted Figure 30; Renumbered Sequentially	17
Updated Outline Dimensions	18

2/08—Rev. A to Rev. B

Changes to Figure 2	1
Changed V _{VCC} to V _{CC} Throughout	. 3

Identifying the ADM1192 on the I ² C Bus 1	0
General I ² C Timing 1	0
Write and Read Operations1	2
Quick Command 1	2
Write Command Byte 1	2
Write Extended Command Byte 1	3
Read Voltage and/or Current Data Bytes 1	4
Applications Information 1	6
ALERT Output 1	6
SETV Pin 1	6
Kelvin Sense Resistor Connection 1	6
Outline Dimensions 1	17
Ordering Guide 1	17

Added ADC Conversion Time Parameter	3
Changes to Input Current for 00 Decode, IADRLOW, Parameter4	ł
Changes to Input Current for 11 Decode, IADRHIGH, Parameter4	ł
Added Endnote 2	ł
Changes to Figure 6	7
Changes to Figure 17)
Changes to General I ² C Timing Section, Step 3 10	
Changes to Table 510)
Changes to Quick Command Section12	2
Changes to Figure 2112	2
Changes to Table 7	2
Changes to Write Extended Command Byte Section	3
Changes to Figure 2313	3
Changes to Table 9 and Table 1113	3
Changes to Converting ADC Codes to Voltage and	
Current Readings Section14	ł
Changes to Figure 2710	5

4/07—Rev. 0 to Rev. A

Changes to Table 5	. 10
Changes to Figure 18 and Figure 19	. 11
Changes to Figure 23	. 13
Changes to Figure 25 and Figure 26	. 14
Added Applications Information Heading	. 16

9/06—Revision 0: Initial Version

SPECIFICATIONS

 $V_{\rm CC}$ = 3.15 V to 26 V, $T_{\rm A}$ = $-40^{\circ}C$ to +85°C, typical values at $T_{\rm A}$ = 25°C, unless otherwise noted.

Table 1.

Parameter	Min	Тур	Мах	Unit	Test Conditions/Comments
VCC PIN					
Operating Voltage Range, Vcc	3.15		26	V	
Supply Current, Icc		1.7	2	mA	
Undervoltage Lockout, VUVLO		2.8		V	VCC rising
Undervoltage Lockout Hysteresis, VUVLOHYST		80		mV	
MONITORING ACCURACY ¹					
Current Sense Absolute Accuracy					
0°C to +70°C	-1.45		+1.45	%	V _{SENSE} = 75 mV
	-1.8		+1.8	%	$V_{\text{SENSE}} = 50 \text{ mV}$
	-2.8		+2.8	%	$V_{\text{SENSE}} = 25 \text{ mV}$
	-5.7		+5.7	%	$V_{\text{SENSE}} = 12.5 \text{ mV}$
0°C to +85°C	-1.5		+1.5	%	$V_{\text{SENSE}} = 75 \text{ mV}$
	-1.8		+1.8	%	$V_{\text{SENSE}} = 50 \text{ mV}$
	-2.95		+2.95	%	$V_{\text{SENSE}} = 25 \text{ mV}$
	-6.1		+6.1	%	$V_{\text{SENSE}} = 12.5 \text{ mV}$
−40°C to +85°C	-1.95		+1.95	%	$V_{\text{SENSE}} = 75 \text{ mV}$
	-2.45		+2.45	%	$V_{\text{SENSE}} = 50 \text{ mV}$
	-3.85		+3.85	%	$V_{\text{SENSE}} = 25 \text{ mV}$
	-6.7		+6.7	%	V _{SENSE} = 12.5 mV
V _{SENSE} for ADC Full Scale ²		105.84		mV	
Voltage Sense Accuracy					
0°C to +70°C	-0.85		+0.85	%	$V_{cc} = 3.0 \text{ V}$ to 5.5 V (low range)
	-0.9		+0.9	%	$V_{cc} = 10.8 V$ to 16.5 V (high range)
0°C to +85°C	-0.85		+0.85	%	$V_{cc} = 3.0 \text{ V to } 5.5 \text{ V} (\text{low range})$
					_
	-0.9		+0.9	%	V_{CC} = 10.8 V to 16.5 V (high range)
–40°C to +85°C	-0.9		+0.9	%	$V_{CC} = 3.0 V$ to 5.5 V (low range)
	-1.15		+1.15	%	V _{CC} = 10.8 V to 16.5 V (high range)
V _{cc} for ADC Full Scale ³					
Low Range (VRANGE = 1)		6.65		V	
High Range (VRANGE = 0)		26.52		V	
CLRB PIN					
Logic Low Threshold, V _{CLRBL}			0.8	V	
Input Current for Logic Low Input, Iclrbl	-40	-22		μΑ	$V_{CLRB} = 0 V$ to 0.8 V
Logic High Threshold, VCLRBH	1.6			mV	
Input Current for Logic High Input, ICLRBH		3	6	μΑ	$V_{CLRB} = 1.6 V \text{ to } 5.5 V$
ADC CONVERSION TIME ⁴		150		μs	
SENSE PIN					
Input Current, I _{sense}	-1		+1	μΑ	$V_{SENSE} = V_{CC}$
SETV PIN					
Overcurrent Trip Threshold	98	100	102	mV	$V_{SETV} = 1.8 V$
	49.5	50	50.5	mV	$V_{SETV} = 0.9 V$
$Overcurrent Trip Gain, V_{SETV}/(V_{CC} - V_{SENSE})$		18			$V_{SETV} = 0.9 V$ to 1.9 V
Input Current, Isetvleak	-1		+1	μΑ	$V_{SETV} = 0.9 V \text{ to } 1.9 V$
Glitch Filter, t _{SETVGLITCH}		3		μs	

ADM1192

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
TIMER PIN					
Pull-Up Current (Overcurrent Fault), ITIMERUPOC	-46	-62	-78	μA	$(18.125 \times V_{SENSE}) > V_{SETV}, V_{TIMER} = 1 V$
Pull-Down Current, ITIMERDN		100		μA	Normal operation, $V_{\text{TIMER}} = 1 \text{ V}$
Pin Threshold High, VTIMERH	1.275	1.3	1.325	v	TIMER rising
ALERT PIN					
Output Low Voltage, VALERTOL		0.05	0.1	v	$I_{ALERT} = -100 \ \mu A$
		1	1.5	mA	$I_{ALERT} = -2 \text{ mA}$
Input Current, I _{ALERT}	-1		+1	μΑ	$V_{ALERT} = V_{CC}$; ALERT asserted
ADR PIN					
Set Address to 00, V _{ADRLOWV}	0		0.8	v	Low state
Set Address to 01, Radrlowz	80	120	160	kΩ	Resistor to ground state, load pin with specified resistance for 01 decode
Set Address to 10, Iadrhighz	-0.3		+0.3	μΑ	Open state, maximum load allowed on ADR pin for 10 decode
Set Address to 11, V _{ADRHIGHV}	2		5.5	V	High state
Input Current for 00 Decode, IADRLOW	-40	-25		μΑ	$V_{ADR} = 0 V \text{ to } 0.8 V$
Input Current for 11 Decode, IADRHIGH		3	6	μA	$V_{ADR} = 2.0 V \text{ to } 5.5 V$
I ² C TIMING					
Low Level Input Voltage, V _{IL}			0.3 VBUS	v	$V_{BUS} = 3.0 \text{ V to } 5.5 \text{ V}$
High Level Input Voltage, V _{IH}	0.7 V _{BUS}			v	$V_{BUS} = 3.0 V \text{ to } 5.5 V$
Low Level Output Voltage on SDA, Vol			0.4	v	$I_{OL} = 3 \text{ mA}$
Output Fall Time on SDA from VIHMIN to VILMAX	$20 + 0.1 C_{BUS}$		250	ns	C_{BUS} = bus capacitance from SDA to GND
Maximum Width of Spikes Suppressed by Input Filtering on SDA Pin and SCL Pin	50		250	ns	
Input Current, ۱، on SDA/SCL When Not Driving a Logic Low Output	-10		+10	μΑ	
Input Capacitance on SDA/SCL		5		рF	
SCL Clock Frequency, fscl			400	kHz	
Low Period of the SCL Clock	600			ns	
High Period of the SCL Clock	1300			ns	
Setup Time for Repeated Start Condition, tsu;sta	600			ns	
SDA Output Data Hold Time, t _{HD;DAT}	100		900	ns	
Setup Time for a Stop Condition, tsu;sto	600			ns	
Bus Free Time Between a Stop and a Start Condition, t _{BUF}	1300			ns	
Capacitive Load for Each Bus Line			400	рF	

¹ Monitoring accuracy is a measure of the error in a code that is read back for a particular voltage/current. This is a combination of amplifier error, reference error, ADC error, and error in ADC full-scale code conversion factor. ² This is an absolute value to be used when converting ADC codes to current readings; any inaccuracy in this value is factored into absolute current accuracy values (see the

Specifications for the Current Sense Absolute Accuracy parameter).

³ These are absolute values to be used when converting ADC codes to voltage readings; any inaccuracy in these values is factored into voltage accuracy values (see the Specifications for the Voltage Sense Accuracy parameter). ⁴ Time between the receipt of the command byte and the actual ADC result being placed in the register.

ABSOLUTE MAXIMUM RATINGS

Table 2.

Tuble 2.	1
Parameter	Rating
VCC Pin	30 V
SENSE Pin	30 V
TIMER Pin	–0.3 V to +6 V
CLRB Pin	–0.3 V to +6 V
SETV Pin	30 V
ALERT Pin	30 V
SDA Pin, SCL Pin	–0.3 V to +6 V
ADR Pin	–0.3 V to +6 V
Storage Temperature Range	-65°C to +125°C
Operating Temperature Range	-40°C to +85°C
Lead Temperature (Soldering 10 sec)	300°C
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL CHARACTERISTICS

 θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 3. Thermal Resistance

Package Type	Αιθ	Unit
10-Lead MSOP	137.5	°C/W

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 3. Pin Configuration

Table 4. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	VCC	Positive Supply Input Pin. The operating supply voltage range is 3.15 V to 26 V. An undervoltage lockout (UVLO) circuit resets the ADM1192 when a low supply voltage is detected.
2	SENSE	Current Sense Input Pin. A sense resistor between the VCC pin and the SENSE pin generates a voltage across a sense resistor. This voltage is proportional to the load current. A current sense amplifier amplifies this voltage before it is digitized by the ADC.
3	SETV	Input Pin. The voltage driven onto this pin is compared with the output of the internal current sense amplifier. The lower the voltage on the SETV, the lower the current level that causes the ALERT output to assert. Typical response time is 1 μ s to 2 μ s.
4	GND	Chip Ground Pin.
5	TIMER	Timer Input Pin. An external capacitor, C _{TIMER} , sets the timing period for masking overcurrent conditions. This timing period should be sufficient to allow the inrush current to completely charge up the load without tripping an overcurrent fault. This makes the device robust against false triggering due to current transients.
6	SCL	I ² C Clock Pin. Open-drain input; requires an external resistive pull-up.
7	SDA	I ² C Data I/O Pin. Open-drain input/output; requires an external resistive pull-up.
8	ADR	I ² C Address Pin. This pin can be tied low, tied high, left floating, or tied low through a resistor to set four I ² C addresses.
9	CLRB	Clear Pin. A latched overcurrent condition can be cleared by toggling this pin low. Holding this pin low disables the ALERT output.
10	ALERT	Alert Output Pin. Active high, open-drain configuration. This pin asserts high when an overcurrent condition is present. The level at which an overcurrent condition is detected depends on either the voltage on the SETV pin or the value in the ALERT_TH register. The ALERT_EN register determines which is used in the comparison. This pin has a latching function and must be cleared manually using either the ALERT_EN register or the CLRB pin.

TYPICAL PERFORMANCE CHARACTERISTICS

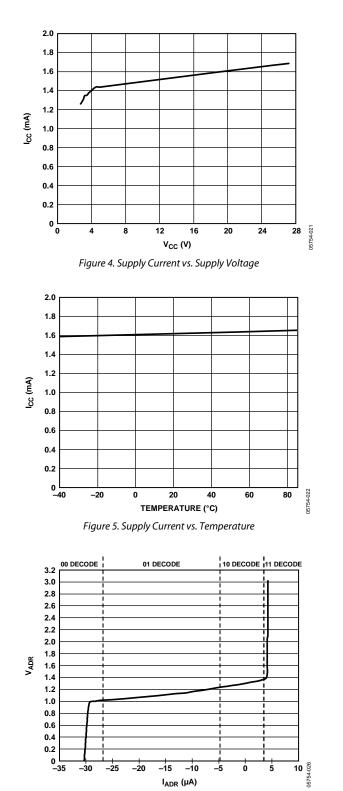


Figure 6. Address Pin Voltage vs. Address Pin Current for Four Addressing Options on Each Address Pin

I_{ADR} (μΑ)

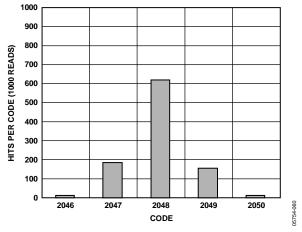


Figure 7. ADC Noise with Current Channel, Midcode Input, and 1000 Reads

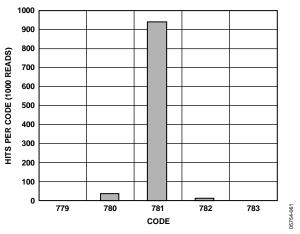


Figure 8. ADC Noise with 14:1 Voltage Channel, 5 V Input, and 1000 Reads

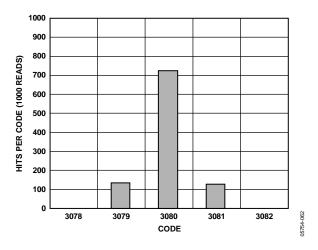


Figure 9. ADC Noise with 7:1 Voltage Channel, 5 V Input, and 1000 Reads

ADM1192

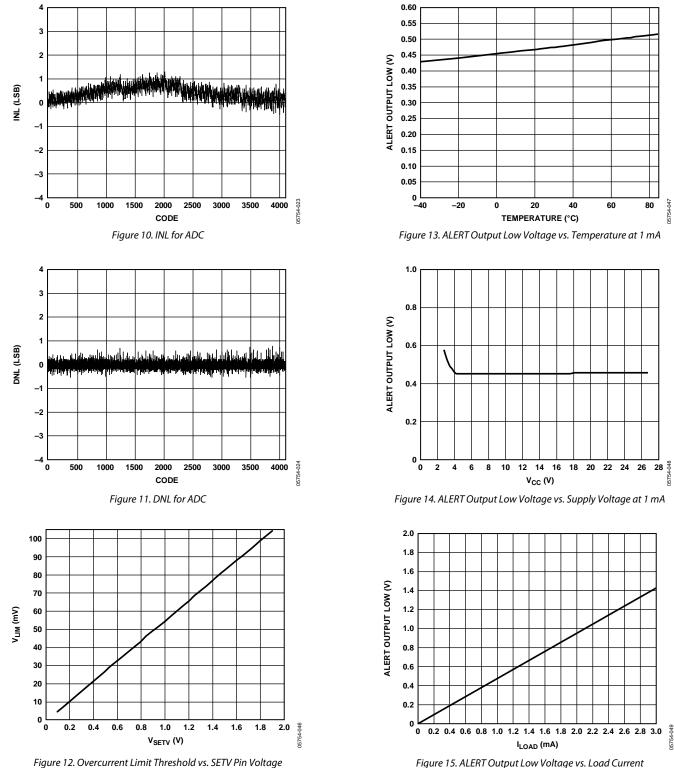
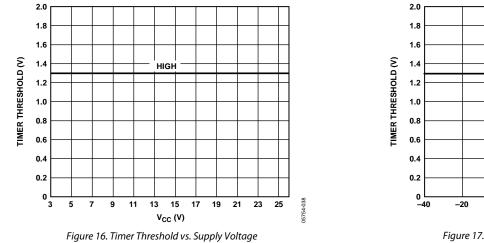
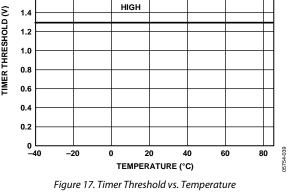


Figure 15. ALERT Output Low Voltage vs. Load Current

Data Sheet

ADM1192





VOLTAGE AND CURRENT READBACK

The ADM1192 contains the components to allow voltage and current readback over an I²C bus. The voltage output of the current sense amplifier and the voltage on the VCC pin are fed into a 12-bit ADC via a multiplexer. The device can be instructed to convert voltage and/or current at any time during operation via an I²C command. When all conversions are complete, the voltage and/or current values can be read back with 12-bit accuracy in two or three bytes.

SERIAL BUS INTERFACE

Control of the ADM1192 is carried out via the serial system management bus (I²C). This interface is compatible with the I²C fast mode (400 kHz maximum). The ADM1192 is connected to this bus as a slave device, under the control of a master device.

IDENTIFYING THE ADM1192 ON THE I²C BUS

The ADM1192 has a 7-bit serial bus slave address. When the device powers up, it does so with a default serial bus address. The five MSBs of the address are set to 01011; the two LSBs are determined by the state of the ADR pin. There are four configurations available on the ADR pin that correspond to four I²C addresses for the two LSBs (see Table 5). This scheme allows four ADM1192 devices to operate on a single I²C bus.

GENERAL I²C TIMING

Figure 18 and Figure 19 show timing diagrams for general write and read operations using the I²C. The I²C specification defines conditions for different types of read and write operations, which are discussed in the Write and Read Operations section. The general I²C protocol operates as follows:

1. The master initiates a data transfer by establishing a start condition, defined as a high-to-low transition on the serial data line, SDA, while the serial clock line, SCL, remains high. This indicates that a data stream is to follow. All slave peripherals connected to the serial bus respond to the start condition and shift in the next eight bits, consisting of a 7-bit slave address (MSB first) plus an R/\overline{W} bit that determines the direction of the data transfer, that is, whether data is written to or read from the slave device (0 = write, 1 = read).

The peripheral whose address corresponds to the transmitted address responds by pulling the data line low during the low period before the ninth clock pulse, known as the acknowledge bit, and holding it low during the high period of this clock pulse. All other devices on the bus now remain idle while the selected device waits for data to be read from it or written to it. If the R/\overline{W} bit is 0, the master writes to the slave device. If the R/\overline{W} bit is 1, the master reads from the slave device.

2. Data is sent over the serial bus in sequences of nine clock pulses: eight bits of data followed by an acknowledge bit from the slave device. Data transitions on the data line must occur during the low period of the clock signal and remain stable during the high period because a low-to-high transition when the clock is high can be interpreted as a stop signal.

If the operation is a write operation, the first data byte after the slave address is a command byte. This tells the slave device what to expect next. It can be an instruction, such as telling the slave device to expect a block write, or it can be a register address that tells the slave where subsequent data is to be written.

Because data can flow in only one direction, as defined by the R/\overline{W} bit, it is not possible to send a command to a slave device during a read operation. Before performing a read operation, it may be necessary to first execute a write operation to tell the slave what sort of read operation to expect and/or the address from which data is to be read.

3. When all data bytes are read or written, stop conditions are established. In write mode, the master pulls the data line high during the 10th clock pulse to assert a stop condition. In read mode, the master device releases the SDA line during the SCL low period before the ninth clock pulse, but the slave device does not pull it low. This is known as a no acknowledge. The master then takes the data line low during the SCL low period before the 10th clock pulse, and then high during the 10th clock pulse to assert a stop condition.

Base Address ADR Pin State		ADR Pin Logic State	Address in Binary ¹	Address in Hex
01011	Ground	00	0101100X	0x58
	Resistor to ground	01	0101101X	0x5A
	Floating	10	0101110X	0x5C
	High	11	0101111X	0x5E

Table 5. Setting I²C Addresses via the ADR Pin

 1 X = don't care.

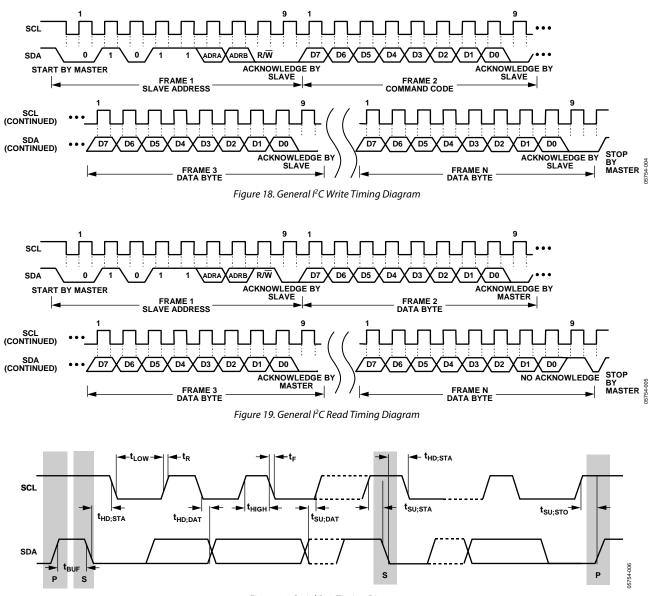


Figure 20. Serial Bus Timing Diagram

WRITE AND READ OPERATIONS

The I²C specification defines several protocols for different types of read and write operations. The operations used in the ADM1192 are discussed in this section. Table 6 shows the abbreviations used in the command diagrams (see Figure 21 to Figure 26).

Table 6. I²C Abbreviations

Abbreviation	Condition
S	Start
Р	Stop Read
R	Read
W	Write
Α	Acknowledge
Ν	No acknowledge

QUICK COMMAND

The quick command operation allows the master to check if the slave is present on the bus, as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the write bit (low).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master asserts a stop condition on SDA to end the transaction.



Figure 21. Quick Command

WRITE COMMAND BYTE

In the write command byte operation, the master device sends a command byte to the slave device, as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the write bit (low).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master sends the command byte. The command byte is identified by an MSB = 0. An MSB = 1 indicates an extended register write (see the Write Extended Command Byte section).
- 5. The slave asserts an acknowledge on SDA.
- 6. The master asserts a stop condition on SDA to end the transaction.

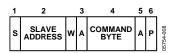


Figure 22. Write Command Byte

The seven LSBs of the command byte are used to configure and control the ADM1192. Table 7 provides details of the function of each bit.

Table 7. Command Byte Operations							
Bit	Default	Name	Function				

Bit	Default	Name	Function
C0	0	V_CONT	LSB, set to convert voltage continuously. If readback is attempted before the first conversion is complete, the ADM1192 asserts an acknowledge and returns all 0s in the returned data.
C1	0	V_ONCE	Set to convert voltage once. Self-clears. I ² C asserts a no acknowledge on attempted reads until the ADC conversion is complete.
C2	0	I_CONT	Set to convert current continuously. If readback is attempted before the first conversion is complete, the ADM1192 asserts an acknowledge and returns all 0s in the returned data.
C3	0	I_ONCE	Set to convert current once. Self-clears. I ² C asserts a no acknowledge on attempted reads until the ADC conversion is complete.
C4	0	VRANGE	Selects different internal attenuation resistor networks for voltage readback. A 0 in C4 selects a 14:1 voltage divider. A 1 in C4 selects a 7:2 voltage divider. With an ADC full scale of 1.902 V, the voltage at the VCC pin for an ADC full-scale result is 26.52 V for VRANGE = 0 and 6.65 V for VRANGE = 1.
C5	0	Not applicable	Unused.
C6	0	STATUS_RD	Status Read. When this bit is set, the data byte read back from the ADM1192 is the status byte. This contains the status of the device alerts. See Table 15 for full details of the status byte.

In the write extended command byte operation, the master device writes to one of the three extended registers of the slave device, as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the write bit (low).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master sends the register address byte. The MSB of this byte is set to 1 to indicate an extended register write. The two LSBs indicate which of the three extended registers are to be written to (see Table 8). All other bits should be set to 0.
- 5. The slave asserts an acknowledge on SDA.
- 6. The master sends the extended command byte (refer to Table 9, Table 10, and Table 11).

- 7. The slave asserts an acknowledge on SDA.
- 8. The master asserts a stop condition on SDA to end the transaction.

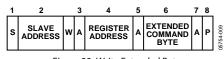


Figure 23. Write Extended Byte

Table 9, Table 10, and Table 11 provide the details of each extended register.

Table 8. Extended Register Addresses

A6 A5 A4			A3	A2	A1	A0	Extended Register
0	0	0	0	0	0	1	ALERT_EN
0	0	0	0	0	1	0	ALERT_TH
0	0	0	0	0	1	1	CONTROL

Bit	Default	Name	Function
0	0	EN_ADC_OC1	LSB, enabled if a single ADC conversion on the I channel exceeds the threshold set in the ALERT_TH register.
1	0	EN_ADC_OC4	Enabled if four consecutive ADC conversions on the I channel exceed the threshold set in the ALERT_TH register.
2	1	EN_OC_ALERT	Enables the OC_ALERT register. If an overcurrent condition is present compared to the SETV threshold, and the TIMER pin charges to 1.3 V, the OC_ALERT register captures and latches this condition.
3	0	EN_OFF_ALERT	Enables an alert if the hot swap operation is turned off by an operation that writes the SWOFF bit high. This allows a software override of the ALERT output and turns on a P-channel FET controlled by ALERT.
4	0	CLEAR	Clears the OC_ALERT and ADC_ALERT status bits in the status register. The value of these bits can immediately change if the source of the alert is not cleared and the alert function is not disabled. The CLEAR bit self-clears to 0 after the STATUS register bits are cleared.

Table 9. ALERT_EN Register Operations

Table 10. ALERT_TH Register Operations

Bit	Default	Function
[7:0]	FF	The ALERT_TH register sets the current level at which an alert occurs. Defaults to ADC full scale. The ALERT_TH 8-bit
		value corresponds to the top eight bits of the current channel data.

Table 11. CONTROL Register Operations

Bit	Default	Name	Function
0	0	SWOFF	LSB, forces the ALERT pin to deassert. Can be active only if the EN_OFF_ALERT bit is high (see Table 9).

READ VOLTAGE AND/OR CURRENT DATA BYTES

Depending on how the device is configured, the ADM1192 can be set up to provide information in three ways after a conversion (or conversions): voltage and current readback, voltage only readback, and current only read back. See the Write Command Byte section for more details.

Voltage and Current Readback

The ADM1192 digitizes both voltage and current. Three bytes are read back in the format shown in Table 12.

Table 12. Voltage and Current Readback Format

Byte	Contents	B7	B6	B5	B4	B3	B2	B1	B0
1	Voltage MSBs	V11	V10	V9	V8	V7	V6	V5	V4
2	Current MSBs	111	110	19	18	17	16	15	14
3	LSBs	V3	V2	V1	V0	13	12	11	10

Voltage Readback

The ADM1192 digitizes voltage only. Two bytes are read back in the format shown in Table 13.

Table 13. Voltage Only Readback Format

Byte	Contents	B7	B6	B5	B4	B3	B2	B1	BO
1	Voltage MSBs	V11	V10	V9	V8	V7	V6	V5	V4
2	Voltage LSBs	V3	V2	V1	V0	0	0	0	0

Current Readback

The ADM1192 digitizes current only. Two bytes are read back in the format shown in Table 14.

Table 14. Current Only Readback Format

Byte	Contents	B7	B6	B5	B4	B3	B2	B1	B0
1	Current MSBs	111	110	19	18	17	16	15	14
2	Current LSBs	13	12	11	10	0	0	0	0

The following series of events occurs when the master receives three bytes (voltage and current data) from the slave device:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the read bit (high).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master receives the first data byte.
- 5. The master asserts an acknowledge on SDA.
- 6. The master receives the second data byte.
- 7. The master asserts an acknowledge on SDA.
- 8. The master receives the third data byte.
- 9. The master asserts a no acknowledge on SDA.
- 10. The master asserts a stop condition on SDA, and the transaction ends.

For cases where the master is reading voltage only or current only, two data bytes are read and Step 7 and Step 8 are not required.

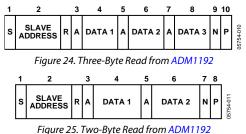


Figure 25. Two-Byte Read from ADM1192

Converting ADC Codes to Voltage and Current Readings

Equation 1 and Equation 2 can be used to convert ADC codes representing voltage and current from the ADM1175 12-bit ADC into actual voltage and current values.

$$Voltage = (V_{FULLSCALE}/4096) \times Code$$
(1)

where:

 $V_{FULLSCALE}$ = 6.65 V (7:2 range) or 26.52 V (14:1 range). *Code* is the ADC voltage code read from the device (Bit V11 to Bit V0).

$$Current = ((I_{FULLSCALE}/4096) \times Code)/Sense Resistor$$
(2)

where:

 $I_{FULLSCALE} = 105.84 \text{ mV}.$

Code is the ADC current code read from the device (Bit I11 to Bit I0).

Read Status Register

A single register of status data can also be read from the ADM1192 as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the read bit (high).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master receives the status byte.
- 5. The master asserts an acknowledge on SDA.

1	2		3	4	5	
s	SLAVE ADDRESS	R	A	STATUS BYTE	A	05754-012
			_			

Figure 26. Status Read from ADM1192

Table 15 shows the ADM1192 STATUS registers in detail. Note that Bit 1, Bit 3, and Bit 5 are cleared by writing to Bit 4 (the CLEAR bit) of the ALERT_EN register.

Table 15. Status Byte Operations

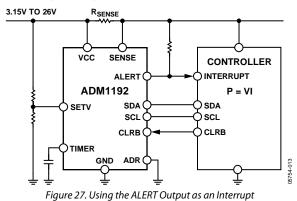
Bit	Name	Function
0	ADC_OC	An ADC-based overcurrent comparison has been detected on the last three conversions.
1	ADC_ALERT	An ADC-based overcurrent trip has occurred, causing the alert. Cleared by writing to Bit 4 of the ALERT_EN register.
2	OC	An overcurrent condition is present (that is, the output of the current sense amplifier is greater than the voltage on the SETV input).
3	OC_ALERT	An overcurrent condition has caused the ALERT block to latch a fault, and the ALERT output has asserted. Cleared by writing to Bit 4 of the ALERT_EN register or by toggling the CLRB pin low.
4	OFF_STATUS	Set to 1 by writing to the SWOFF bit of the CONTROL register.
5	OFF_ALERT	An alert has been caused by the SWOFF bit. Cleared by writing to Bit 4 of the ALERT_EN register.

APPLICATIONS INFORMATION Alert output

The ALERT output is an open-drain pin with 30 V tolerance. There are two uses for this output.

Overcurrent Flag

The ALERT pin can be connected to the general-purpose logic input of a controller. During normal operation, the ADM1192 drives this output low. When an overcurrent condition occurs, the output asserts high. An external pull-up resistor should be used. This pin is configured by default to trigger the SETV threshold at power-up.



Implementing a Basic Hot Swap Circuit

A basic P-channel FET hot swap circuit can be created. The ALERT output should be connected to the GATE pin of a P-channel FET connected in series with the power path. A pull-up from GATE to source ensures that the P-channel FET GATE is pulled up and the device held off as soon as power is applied. When the ADM1192 powers up, the GATE is pulled low by the ALERT output. A capacitor on the ALERT pin determines the slew rate of the GATE pin at startup. Note that, if a current fault occurs during the operation, the ALERT output asserts high, turning off the P-channel FET.

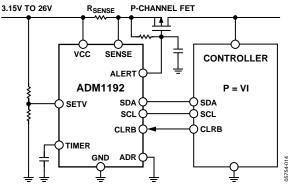


Figure 28. P-Channel FET Hot Swap Implementation

SETV PIN

The SETV pin allows the user to adjust the current level that trips the ALERT output. The output of the current sense amplifier is compared with the voltage driven onto the SETV pin. If the current sense amplifier output is higher than the SETV voltage, the output of the comparator asserts. By driving a different voltage onto the SETV pin, the ADM1192 detects an overcurrent condition at a different current level, with a gain of 18. The 100 mV ADC full-scale sense voltage corresponds to 1.8 V on the SETV pin. See Figure 12 for an illustration of this relationship.

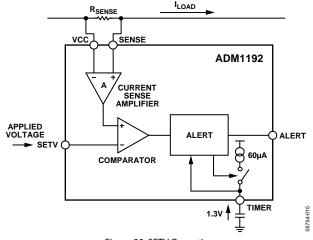


Figure 29. SETV Operation

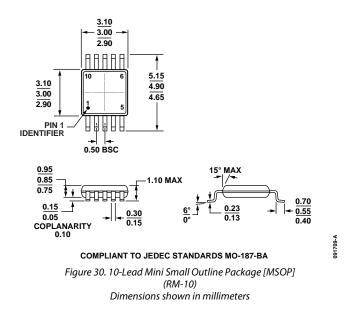
When the output of the SETV comparator asserts, this tells the ALERT block to begin charging the external TIMER capacitor with a 62 μ A charging current. When the voltage on the TIMER capacitor reaches 1.3 V, the charging cycle is complete. The ALERT output then asserts (goes high). Different values of TIMER capacitor generate different time delays between current faults occurring and the ALERT output asserting. When using the ALERT output to implement a hot swap circuit, the TIMER capacitor should be chosen to generate a large enough startup delay to allow the maximum inrush current to completely charge up the load without tripping an ALERT fault.

KELVIN SENSE RESISTOR CONNECTION

When using a low value sense resistor for high current measurement, the problem of parasitic series resistance can arise. The pad and solder resistance can be a substantial fraction of the rated resistance, making the total resistance larger than expected.

This error problem can be largely avoided by using a Kelvin sense connection. This type of connection separates the high current path through the resistor and the voltage drop across the resistor. A four pad resistor may be used or a split pad layout can be used with a two pad sense resistor to achieve Kelvin sensing.

OUTLINE DIMENSIONS



ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option	Branding
ADM1192-1ARMZ-R7	-40°C to +85°C	10-Lead MSOP	RM-10	M5M
EVAL-ADM1192EBZ		Evaluation Board		

¹ Z = RoHS Compliant Part.

NOTES

NOTES

NOTES

I²C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

©2006–2013 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners. D05754-0-7/13(D)



www.analog.com

Rev. D | Page 20 of 20

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Current & Power Monitors & Regulators category:

Click to view products by Analog Devices manufacturer:

Other Similar products are found below :

NCP347MTAHTBG NCS37000MNG NCP4353BSNT1G MAX4845DEYT+T ZXCT1080QE5TA NCP4353ASNT1G PAC1942T-2E/J6CX PAC1942T-1E/J6CX PAC1941T-1E/J6CX PAC1943T-E/J6CX PAC1944T-E/J6CX PAC1941T-2E/4MX PAC1941T-2E/J6CX PAC1943T-E/4MX NCP361SNT1G ZXCT1023DFGTA ADM1294-1AARUZ-RL7 ZXCT1084QE5TA LTC41511MS-1#PBF LM334S8#PBF INA203AIDR ADM1294-1AACPZ ADM1294-1BACPZ ADL5315ACPZ-R7 ADL5317ACPZ-REEL7 ADM1041ARQZ ADM1192-1ARMZ-R7 ADM1293-1BARUZ ADM1294-1AARUZ LTC1921CMS8#PBF LTC1921IS8#PBF LTC1392CS8#PBF LTC2921CGN#PBF LTC29471UHF-65#PBF ZXCT1009FTA DM7332G-00364-B1 CS5460A-BSZ CS5463-ISZR CS5464-ISZ ZXCT107QSA-7 AP4341SNTR-G1 LT2940IDD#PBF ZXCT1110W5-7 ZXCT1083E5TA ZXCT1020E5TA ZXCT1021E5TA ZXCT1022E5TA ZXCT1051E5TA ZXCT1080E5TA ZXCT1107SA-7